

AS1FD, AS1FG, AS1FJ, AS1FK, AS1FM

Vishay General Semiconductor

AUTOMOTIVE GRADE

RoHS

COMPLIANT

HALOGEN

FREE

Standard Avalanche Surface-Mount Rectifiers

eSMP® Series



SMF (DO-219AB)

Bottom view

Cathode O Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	1.5 A				
V_{RRM}	200 V, 400 V, 600 V, 800 V, 1000 V				
I _{FSM}	30 A				
I _R	0.2 μΑ				
V_F at $I_F = 1$ A	0.84 V				
E _{AS}	20 mJ				
T _J max.	175 °C				
Package	SMF (DO-219AB)				
Circuit configuration	Single				

FEATURES

- Low profile package
- Glass passivated pellet chip junction
- · Ideal for automated placement
- · Low forward voltage drop, low reverse current
- Meets MSL level 1, per J-STD-020;
 LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified
 - Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and automotive grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	AS1FD	AS1FG	AS1FJ	AS1FK	AS1FM	UNIT
Device marking code		ASD	ASG	ASJ	ASK	ASM	
Max. repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Max. DC forward current (see fig. 1)	I _F ⁽¹⁾	1.5			Α		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30			Α		
Non-repetitive avalanche energy at $I_{AS} = 1.0 \text{ A}$, $T_A = 25 ^{\circ}\text{C}$	E _{AS}	20			mJ		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175			°C		

Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area



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ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)							
PARAMETER	TEST C	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 1.0 A	T _J = 25 °C		0.95	-	V	
		T _J = 125 °C	V _E (1)	0.84	-		
	I _F = 1.5 A	T _J = 25 °C	VF ('')	0.99	1.15		
		T _J = 125 °C		0.89	1.0		
Reverse current	Rated V _R	T _J = 25 °C	I _R ⁽²⁾	0.14	5	μА	
		T _J = 125 °C	IR (-)	25	100		
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	1.3	-	μs	
Typical junction capacitance	4.0 V, 1 MHz		CJ	8.8	-	pF	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)							
PARAMETER	SYMBOL	AS1FD	AS1FG	AS1FJ	AS1FK	AS1FM	UNIT
Typical thermal resistance	R _{0JA} (1)(2)	130					°C/W
Typical thermal resistance	$R_{\theta JM}$ (1)	20					C/VV

Notes

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

(2) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

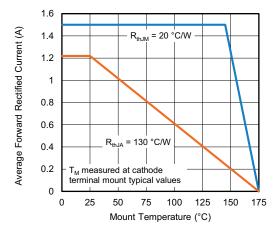
ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
AS1FM-M3/H	0.015	Н	3000	7" diameter plastic tape and reel			
AS1FM-M3/I	0.015	I	10 000	13" diameter plastic tape and reel			
AS1FMHM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel			
AS1FMHM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel			

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)



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Fig. 1 - Max. Forward Current Derating Curve

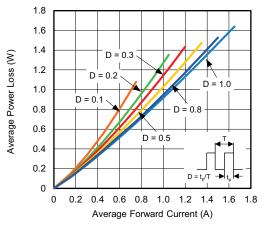


Fig. 2 - Forward Power Loss Characteristics

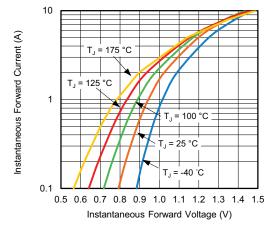


Fig. 3 - Typical Instantaneous Forward Characteristics

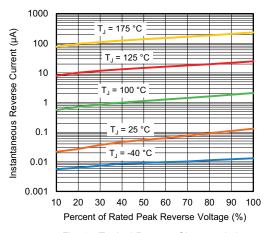


Fig. 4 - Typical Reverse Characteristics

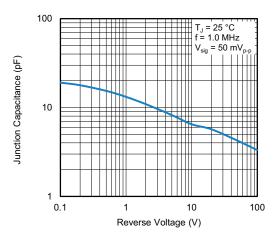


Fig. 5 - Typical Junction Capacitance

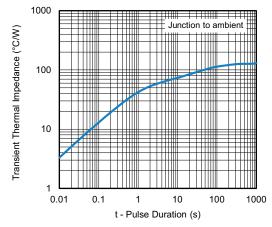
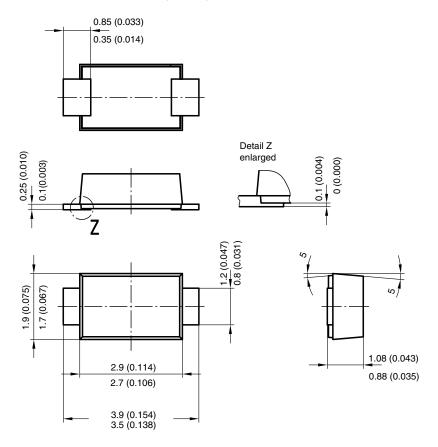


Fig. 6 - Typical Transient Thermal Impedance

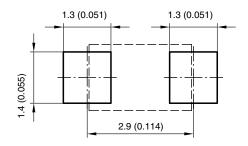
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PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



Created - Date: 15. February 2005 Rev. 3 - Date: 13. March 2007 Document no.: S8-V-3915.01-001 (4) 17247



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